

108-140213 Rev. A2

#### 1. Scope

#### 1.1. Content

This specification describes characteristic, tests and quality requirements for the **UMCC MICRO-COAX RECEPTACLE**, **GENERATION 4 (P/N:** 2334884-1)

### 1.2. Qualification

When testing the named products the following specified specifications and standards shall be used. All tests have to be done using the applicable inspection plan and product drawing.

#### 2. Applicable Documents

The following mentioned documents, if they are referred, are part of this specification. In case of conflict between the requirements of this specification and the product drawing or in conflict between the requirements of this specification and the referenced documents, this specification has got precedence.

#### 2.1. Tyco Electronics Document

501-78726 Test Report

#### 3. Requirements

### 3.1 Design and Construction

The product descripted in this paper is a SMT Type Micro Coaxial RF Receptacle, This SMT type Micro coaxial RF Receptacle products are designed for Mobile phones, Wireless LAN, Mini-PCI, Bluetooth, PDA, GPS, electronic measuring instruments, etc

#### 3.2 Materials

Antenna Element: Stainless Steel, Nickel Plating

### 3.3 Rating

Rated Voltage: 60VAC (R.M.S) Frequency Range: DC 0  $^{\sim}$  12GHz Character Impedance: 50±5  $\Omega$ Operate Temperature: -40  $^{\sim}$  +85  $^{\sim}$ 

Operate Temperature:  $-40^{\circ}$ C  $^{\circ}$  +85  $^{\circ}$ C Storage Temperature Limit : -10  $^{\circ}$  40  $^{\circ}$ C

Operate Humidity: 95% MAX

Guaranty Number of time for Reflow: 2 times

### 3.4 Performance Requirement and Test Description

The Product shall be designed to meet the electrical, mechanical and environmental performance requirement specified in Table.1. All test shall be performed in the room temperature, unless otherwise specified.



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2.5 Test Requirements and Procedures Summary

Para.	Test Items	Requirements	Procedures		
2.5.1	Examination of Product	Meets applicable requirements specified, customer drawing, and application specification.	Visual inspection No physical damage.		
		Electric Performance			
2.5.2	Contact Resistance	(IEC512-2-1(2a)) Solder the receptacle connector to the test board and mate the plug connector together, then measure the contact resistance as Shown in figure 1 by the four terminal method.  Open circuit voltage: 20mV MAX Circuit current: 10mA MAX  Inner Contact/I A - B Ground Contact. D - C	Inner Contact Initial: $20 \text{ m } \Omega$ MAX. After: $20 \text{ m } \Omega$ MAX. Ground Contact Initial: $20 \text{ m } \Omega$ MAX. After: $20 \text{ m } \Omega$ MAX.		
2.5.3	Insulation Resistance	Mate the plug and receptacle connector together, and then apply DC 200 V Voltage.  between the inner contact and the ground contact in accordance with IEC 512-4-1(3a)	Initial: 500 M $\Omega$ Min. After test : 100 M $\Omega$ Min.		
2.5.4	Dielectric withstanding voltage	Mate the plug and receptacle connector Together, and then apply AC 200 V between the inner contact and the ground contact in accordance with IEC 512-4-1(4a)	No flashover, No spark over, No excess leakage, No breakdown		

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2.5.5	V.S.W.R	Measure the V.S.W.R as shown in figure 2 by the network analyzer  Frequency: DC~12GHz  Figure 2  NA  D.U.T Termination	1.3 Max. (DC~3GHz) 1.4Max. (3~6GHz) 1.5Max. (6~9GHz) 1.6Max. (9~12GHz)
		Meannical Performance	
2.5.6	Un-mating Force	IEC 512-15-4(15d) Solder the receptacle connector to the test board and mate the plug connector, then measure the un-mating force at speed of 25± 3mm/minutes along by the push-push machine	1.Initial: 4N (0.4Kgf) Min. 2.After 30 Cycles: 2N(0.2Kgf) Min.
2.5.7	Durability	Mate and un-mate the receptacle connector(soldered to the test board) and plug connector 100 cycles at the speed of 25± 3mm/minutes along the mating direction by the push-push machine	Appearance: No abnormality Contact Resistance: Shall meet 3.5.2
2.5.8	Vibration	IEC 512-6-4(6d) Apply the following vibration to the mating Connector. During the testing, run 100mA DC to check electrical discontinuity. Frequency: 10Hz→ 100Hz→ 10Hz/approx. 20minutes. Half amplitude, Peak value of acceleration: 1.5mm or 59m/s²(6G) Directions,cycle:3 mutually perpendicular direction, 2cycles about each direction	Appearance: No abnormality Contact Resistance: Shall meet 3.5.2 No discontinuities of 1µs or longer duration

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2.5.9	Shock	IEC 512-6-3(6c) The object of this test procedure is to detail a standard method to assess the ability of a connector to withstand specified severity of Mechanical shock. Peak value of acceleration:735m/s²(75G) Duration :11ms Wave form : half sinusoidal Directions, cycle : 6 mutually perpendicular direction, 3cycles about each direction	Appearance: No abnormality Contact Resistance: Shall meet: 3.5.2 No discontinuities of 1µs or longer duration
3.5.10	Humidity	Environment Performance  Apply the following environment to the mating connector in accordance with IEC 512-11-3(11c)  Temperature: 25~65°C  Humidity: 90~95%R.H  Duration: 96 hours	Appearance: No abnormality Contact Resistance: Shall meet 3.5.2 Insulation Resistance: Shall meet 3.5.3 Dielectric withstanding voltage Shall meet 3.5.4
3.5.11	Thermal Shock	Apply the following environment to the mating connector in accordance with IEC 512-11-4(11d)  Temperature: -55~85°C  Transition time: : 5min. MAX  Cycles: 5 Cycles	Appearance: No abnormality Contact Resistance: Shall meet 3.5.2 Insulation Resistance: Shall meet 3.5.3 Dielectric withstanding voltage Shall meet 3.5.4
3.5.12	Resistance to soldering heat	According to 8.8.1,Apply reflow soldering Condition.  Measurement after 24h+/-2h.	Appearance: No abnormality Contact Resistance: Shall meet 3.5.2 Insulation Resistance: Shall meet 3.5.3 Dielectric withstanding voltage Shall meet 3.5.4



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3.5.13	Salt Spray	IEC 512-11-6(11f) Apply the following environment to the mating connector	Appearance: No abnormality Contact Resistance: Shall meet 3.5.2
		Temperature: 35±2°C	
		Relative Humidity: 90~98%R.H Salt water density: 5±1% Duration: 48 hours	
3.5.14	Solderability	Apply the following environment to the mating connector	At least 95% covered by a continuous new solder coating.
		Temperature: 245±2°C	
		Duration: 3~5 second	
		Test sample should be observed by the Magnification of 10times after the test.	

Table. 1

## 2.6 Test Sequence and Sample Quantity

	Test Group								
Test Item	Α	В	С	D	Е	F	G	Н	I
		1	1	(a)	)	ı	ı		
Examination of product	1,	1,6	1,5	1,6	1,6	1,6	1,6	1,4	1,3
Contact Resistance		2,7	2,4	2,4	2,7	2,7	2,7	2,5	
Insulation resistance					3,8	3,8	3,8		
Dielectric Withstanding Voltage					4,9	4,9	4,9		
V.S.W.R	2,								
Un-mating Force		3,5							
Durability		4,							
Vibration			3,						
Shock				3,					
Humidity					5,				
Thermal Shock						5,			

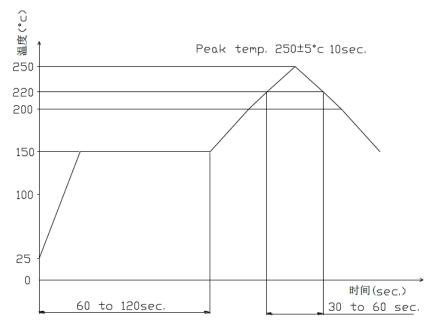


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High Temperature Life							5,		
Salt Spray								3,	
Solderability									2,
Sample QTY(PCS)	5	5	5	5	5	5	5	5	5

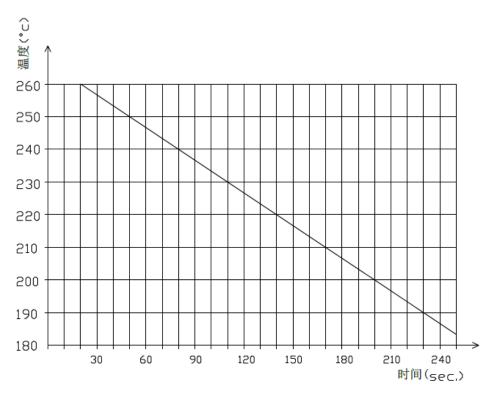
## 4. SMT Temperature Curve

- 4.1 Temperature profile of reflow soldering
- 4.1.1 Recommended tem. & time relative curve of Re-flow.

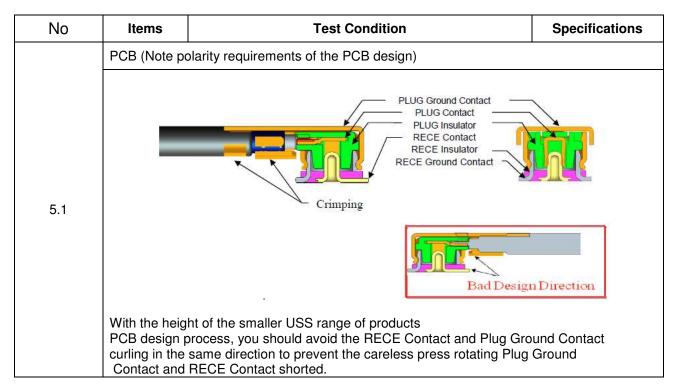


4.2.2 Extreme tem. &time curve of Re-flow





## 5. Usage Precaution





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5.2	Stockpile condition	<ol> <li>Storage Temperature -10 °C ~ + 40 °C</li> <li>Operating humidity 85% R.H.MAX</li> <li>Validity: Use within 6 months after receiving the Product</li> </ol>	
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